



- Notes:
- R112 for test purposes only
  - Spin of PMP7182\_RevB
  - built on PCB PMP7182\_RevA
  - RefDes >= 200 assembled additional



Title			Isolated Flyback		
Size	Number	Rev			
C	PMP8650	A			
Date	07/08/2013	Drawn by F. Mueller			
Engineer	F. Mueller	Filename	PMP8650_RevA.sch	Sheet	1 of 1

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